THIN FILM SURFACE MOUNT

# Low Pass Filter

# ALF-12000+

50Ω DC to 12 GHz

## KEY FEATURES

- Low Passband Insertion Loss of 0.5 dB Typ.
- High Rejection of 47 dB Typ.
- Good Return Loss of 17 dB Typ.
- Small Size, 5.59 x 8.13 x 2.03 mm

*Generic photo used for illustration purposes only*

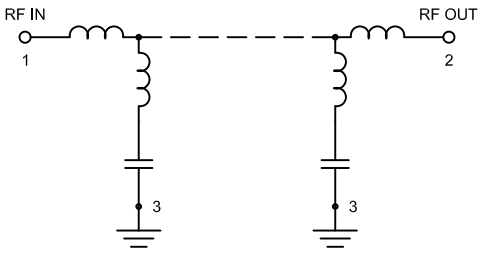
## APPLICATIONS

- Telecommunications and broad band wireless systems.
- Military applications.
- SATCOM modems.
- Test and measurements

## PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.

## FUNCTIONAL DIAGRAM




## ELECTRICAL SPECIFICATIONS[1,2] AT +25°C

| Parameter | | F# | Frequency (GHz) | Min. | Typ. | Max. | Units |
|---|---|---|---|---|---|---|---|
| Pass Band | Insertion Loss | DC-F1 | DC - 12 | — | 0.5 | 1.2 | dB |
| | Freq. Cut-Off[3] | Fc | 13.95 | — | 3 | — | dB |
| | Return Loss | DC-F1 | DC - 12 | — | 17 | — | dB |
| Stop Band | Rejection | F2-F3 | 15.6 - 17 | 25 | 38 | — | dB |
| | | F3-F4 | 17 - 20 | 35 | 47 | — | |
| | | F4-F5 | 20 - 25 | — | 30 | — | |

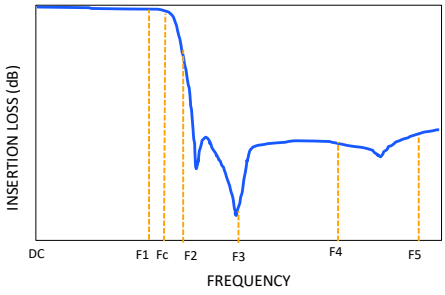
1. Tested in Evaluation Board P/N TB-ALF-12000+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.
2. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required
3.Typical variation ±3%

## ABSOLUTE MAXIMUM RATINGS[4]

| Parameter | Ratings |
|---|---|
| Operating Temperature | -55°C to +125°C |
| Storage Temperature | -55°C to +125°C |
| Input Power[5] | 12 W Max. at 25°C |

4. Permanent damage may occur if any of these limits are exceeded.
5. Power rating applies only to signals within the passband. Derated power at +125 degC is 4 W.

## TYPICAL FREQUENCY RESPONSE




REV. OR
ECO-021047
ALF-12000+
EDU4653
URJ
240301

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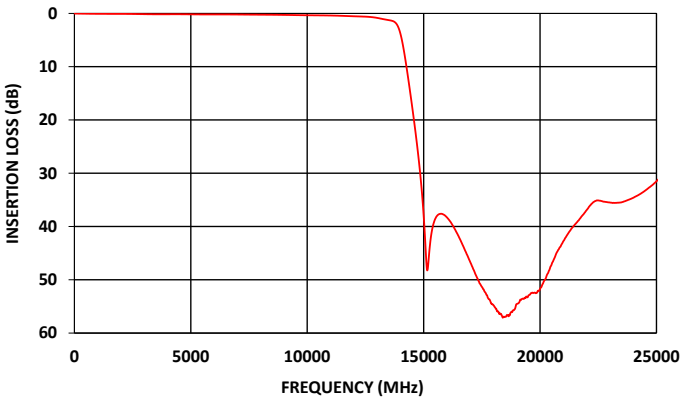
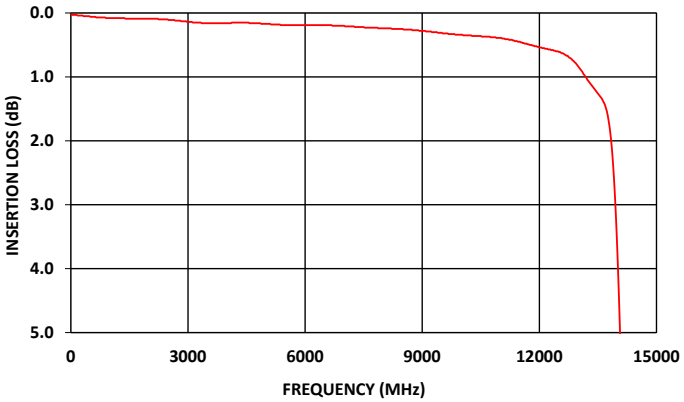
## TYPICAL PERFORMANCE GRAPHS AT +25°C

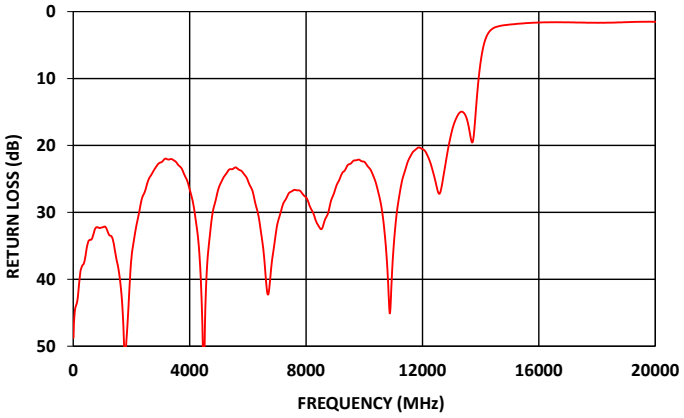
ALF-12000+
INSERTION LOSS



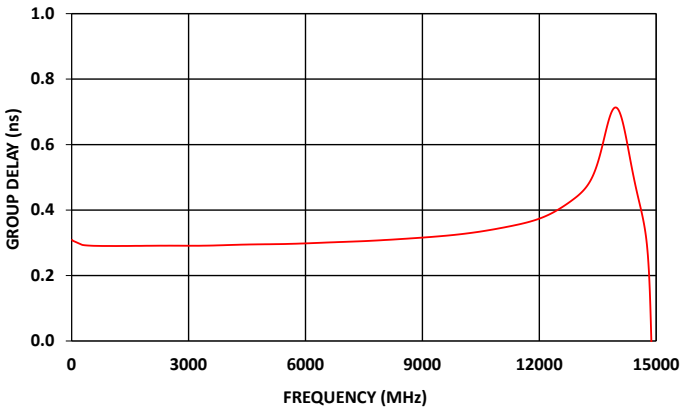

ALF-12000+
INSERTION LOSS (Zoomed)




ALF-12000+
RETURN LOSS




ALF-12000+
GROUP DELAY



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## FUNCTIONAL DIAGRAM

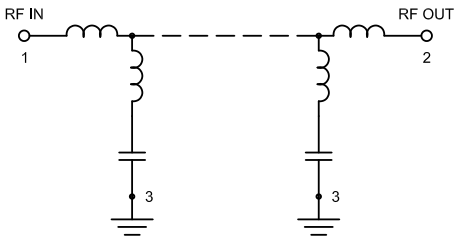
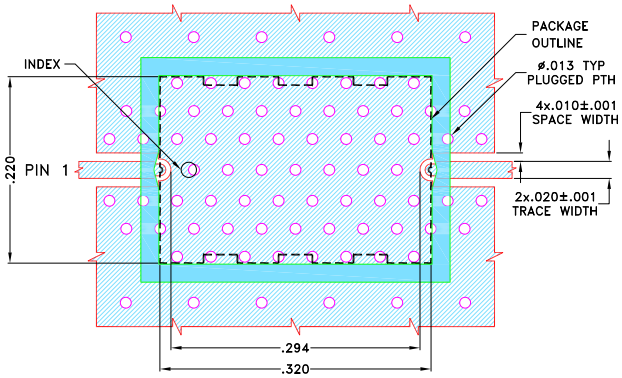



Figure 1. ALF-12000+ Functional Diagram

## PAD DESCRIPTION

| Function | Pad Number | Description |
|---|---|---|
| RF1 | 1 | Connects to RF Input Port |
| RF2 | 2 | Connects to RF Output Port |
| GROUND | 3 | Connects to Ground on PCB, (See drawing PL-652) |
| NC | — | No connection, not used internally. See drawing PL-652 for connection to PCB |

## SUGGESTED PCB LAYOUT (PL-652)



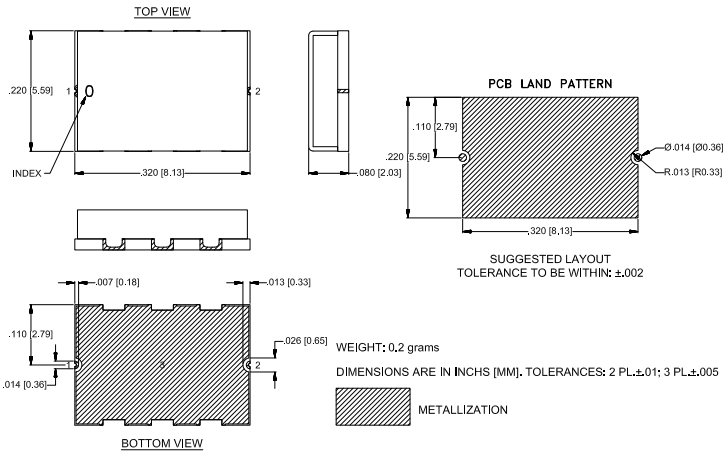

NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .010±.0010. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Figure 2. Suggested PCB Layout PL-652

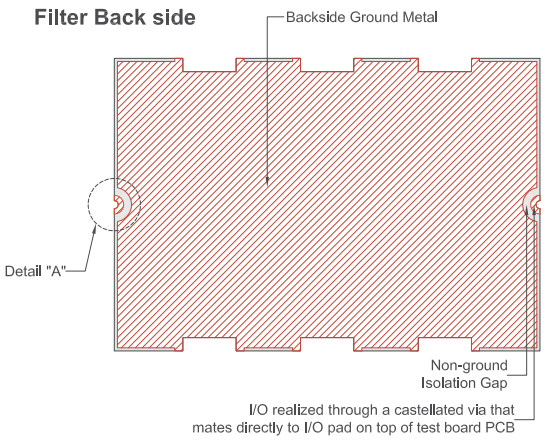
## CASE STYLE DRAWING



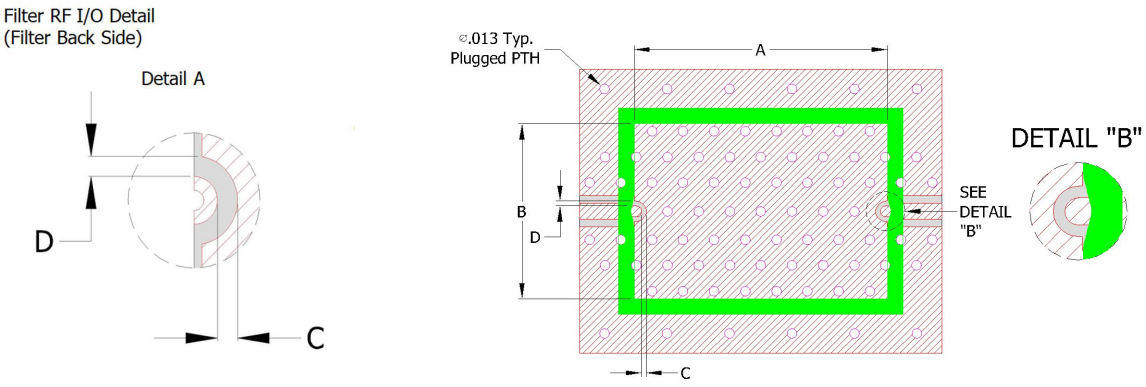

## PRODUCT MARKING*: ALF-12000

*Marking may contain other features or characters for internal lot control.

## RECOMMENDED PCB LAYOUT PATTERN FOR FILTER




PCB Pattern Recommendations

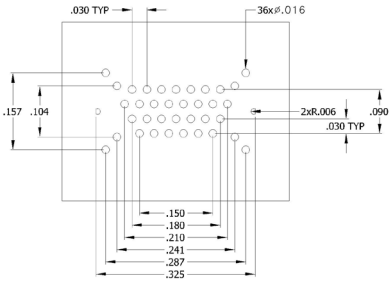



1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).

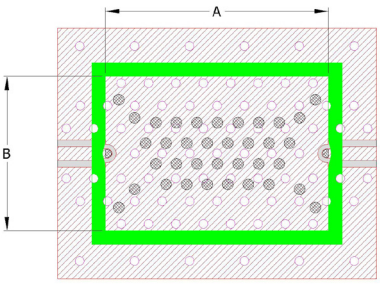
## COMMENTS ON COMPONENT HANDLING AND SOLDER ATTACH

1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing




Solder location after screen print




4) Plugged ground vias in the PWB will improve attachment consistency.
5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.

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**ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.** CLICK HERE

| | |
|---|---|
| **Performance Data and Graphs** | Data<br>Graphs<br>S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads |
| **Case Style** | UC2731 Lead Finish: Gold over Nickel plate. |
| **RoHS Status** | Compliant |
| **Tape and Reel** | TR-F003 |
| **Suggested Layout for PCB Design** | PL-652 |
| **Evaluation Board** | TB-ALF-12000+ |
| | Gerber File |
| **Environmental Rating** | ENV120 |

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html